

# TK60P03M1

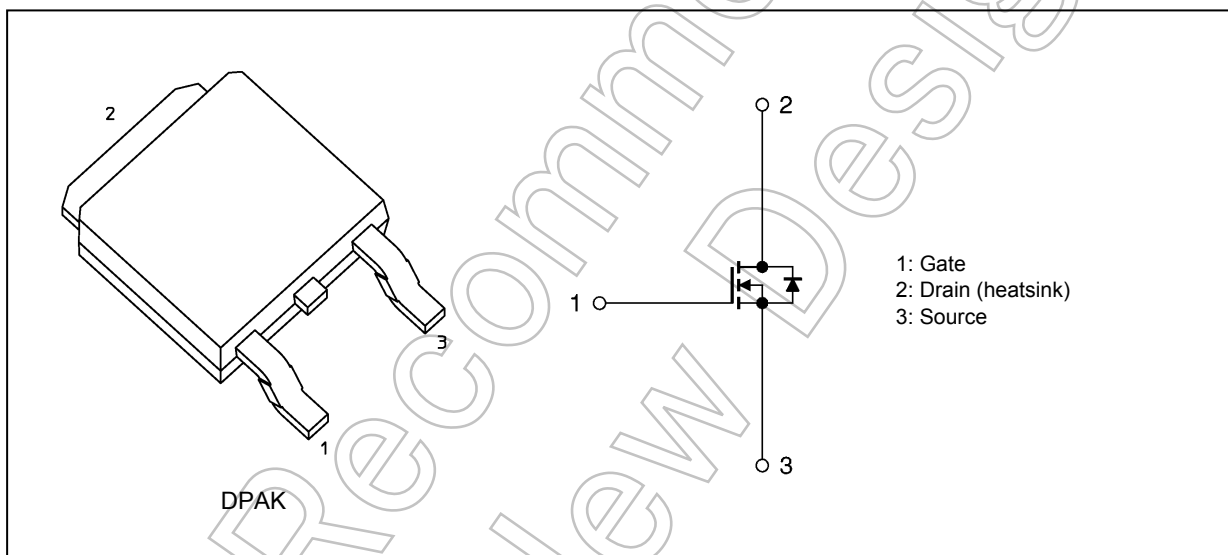
## 1. Applications

- Switching Voltage Regulators
- Motor Drivers
- Power Management Switches

## 2. Features

- (1) High-speed switching
- (2) Low gate charge:  $Q_{SW} = 13 \text{ nC}$  (typ.)
- (3) Low drain-source on-resistance:  $R_{DS(ON)} = 4.6 \text{ m}\Omega$  (typ.) ( $V_{GS} = 10 \text{ V}$ )
- (4) Low leakage current:  $I_{DSS} = 10 \text{ }\mu\text{A}$  (max) ( $V_{DS} = 30 \text{ V}$ )
- (5) Enhancement mode:  $V_{th} = 1.3 \text{ to } 2.3 \text{ V}$  ( $V_{DS} = 10 \text{ V}$ ,  $I_D = 0.5 \text{ mA}$ )

## 3. Packaging and Internal Circuit



#### 4. Absolute Maximum Ratings (Note) ( $T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Rating	Unit
Drain-source voltage	$V_{\text{DSS}}$	30	V
Drain-gate voltage ( $R_{\text{GS}} = 20 \text{ k}\Omega$ )	$V_{\text{DGR}}$	30	
Gate-source voltage	$V_{\text{GSS}}$	$\pm 20$	
Drain current (DC) (Note 1)	$I_{\text{D}}$	60	A
Drain current (pulsed) (Note 1)	$I_{\text{DP}}$	120	
Power dissipation ( $T_c = 25^\circ\text{C}$ )	$P_{\text{D}}$	63	W
Single-pulse avalanche energy (Note 2)	$E_{\text{AS}}$	94	mJ
Single-pulse avalanche current	$I_{\text{AS}}$	60	A
Channel temperature	$T_{\text{ch}}$	150	$^\circ\text{C}$
Storage temperature	$T_{\text{stg}}$	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

#### 5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	$R_{\text{th(ch-c)}}$	1.98	$^\circ\text{C/W}$
Channel-to-ambient thermal resistance	$R_{\text{th(ch-a)}}$	125	

Note 1: Ensure that the channel temperature does not exceed  $150^\circ\text{C}$ .

Note 2:  $V_{\text{DD}} = 24 \text{ V}$ ,  $T_{\text{ch}} = 25^\circ\text{C}$  (initial),  $L = 0.02 \text{ mH}$ ,  $R_{\text{G}} = 1.2 \text{ }\Omega$ ,  $I_{\text{AS}} = 60 \text{ A}$

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

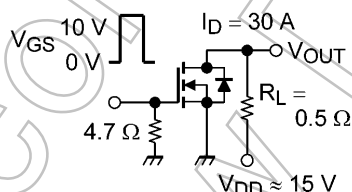
## 6. Electrical Characteristics

### 6.1. Static Characteristics ( $T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	$I_{GSS}$	$V_{GS} = \pm 20\text{ V}$ , $V_{DS} = 0\text{ V}$	—	—	$\pm 0.1$	$\mu\text{A}$
Drain cut-off current	$I_{DSS}$	$V_{DS} = 30\text{ V}$ , $V_{GS} = 0\text{ V}$	—	—	10	
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 10\text{ mA}$ , $V_{GS} = 0\text{ V}$	30	—	—	V
	$V_{(BR)DSX}$	$I_D = 10\text{ mA}$ , $V_{GS} = -20\text{ V}$	15	—	—	
Gate threshold voltage	$V_{th}$	$V_{DS} = 10\text{ V}$ , $I_D = 0.5\text{ mA}$	1.3	—	2.3	
Drain-source on-resistance	$R_{DS(ON)}$	$V_{GS} = 4.5\text{ V}$ , $I_D = 30\text{ A}$	—	5.7	7.8	$\text{m}\Omega$
		$V_{GS} = 10\text{ V}$ , $I_D = 30\text{ A}$	—	4.6	6.4	

### 6.2. Dynamic Characteristics ( $T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input capacitance	$C_{iss}$	$V_{DS} = 10\text{ V}$ , $V_{GS} = 0\text{ V}$ , $f = 1\text{ MHz}$	—	2700	—	$\text{pF}$
Reverse transfer capacitance	$C_{rss}$		—	170	—	
Output capacitance	$C_{oss}$		—	520	—	
Gate resistance	$r_g$	$V_{DS} = 10\text{ V}$ , $V_{GS} = 0\text{ V}$ , $f = 5\text{ MHz}$	—	0.7	1.1	$\Omega$
Switching time (rise time)	$t_r$	See Figure 6.2.1.	—	4.3	—	ns
Switching time (turn-on time)	$t_{on}$		—	15	—	
Switching time (fall time)	$t_f$		—	11	—	
Switching time (turn-off time)	$t_{off}$		—	32	—	



Duty  $\leq 1\%$ ,  $t_w = 10\text{ }\mu\text{s}$   
**Fig. 6.2.1 Switching Time Test Circuit**

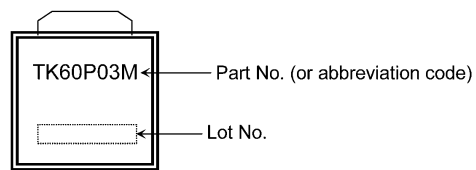
### 6.3. Gate Charge Characteristics ( $T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Total gate charge (gate-source plus gate-drain)	$Q_g$	$V_{DD} \approx 24\text{ V}$ , $V_{GS} = 10\text{ V}$ , $I_D = 60\text{ A}$	—	40	—	nC
		$V_{DD} \approx 24\text{ V}$ , $V_{GS} = 5\text{ V}$ , $I_D = 60\text{ A}$	—	21	—	
Gate-source charge 1	$Q_{gs1}$	$V_{DD} \approx 24\text{ V}$ , $V_{GS} = 10\text{ V}$ , $I_D = 60\text{ A}$	—	11	—	
Gate-drain charge	$Q_{gd}$		—	7.2	—	
Gate switch charge	$Q_{sw}$		—	13	—	

### 6.4. Source-Drain Characteristics ( $T_a = 25^\circ\text{C}$ unless otherwise specified)

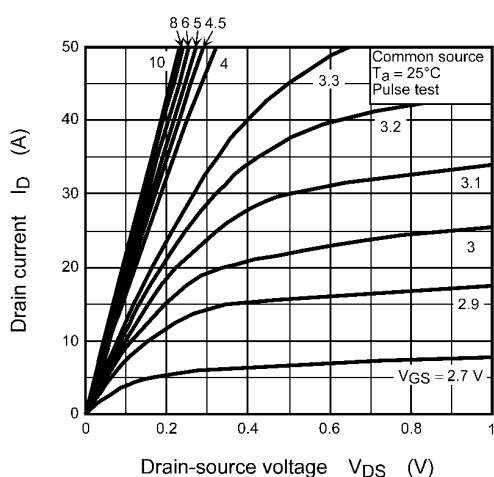
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Reverse drain current (pulsed) (Note 3)	$I_{DRP}$	—	—	—	120	A
Diode forward voltage	$V_{DSF}$	$I_{DR} = 60\text{ A}$ , $V_{GS} = 0\text{ V}$	—	—	-1.2	V

Note 3: Ensure that the channel temperature does not exceed  $150^\circ\text{C}$ .

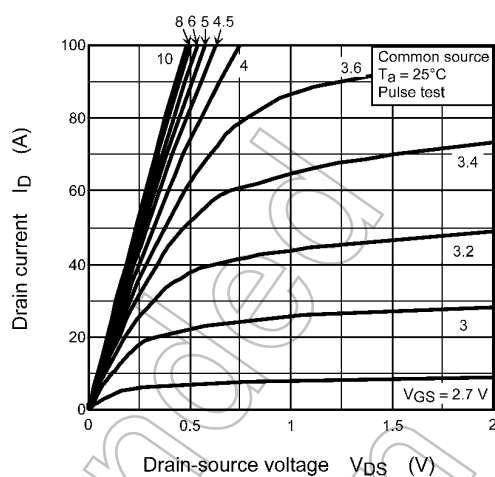
**7. Marking****Fig. 7.1 Marking**

Not Recommended  
for New Design

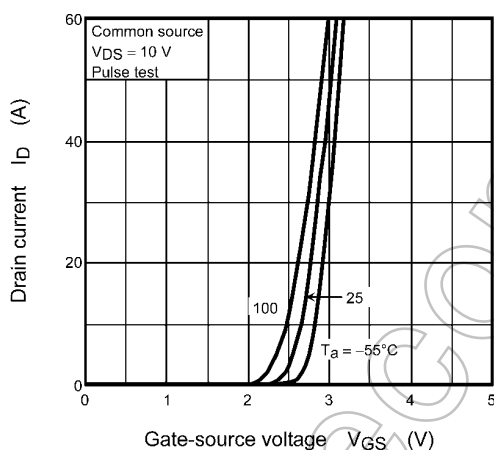
# 8. Characteristics Curves (Note)



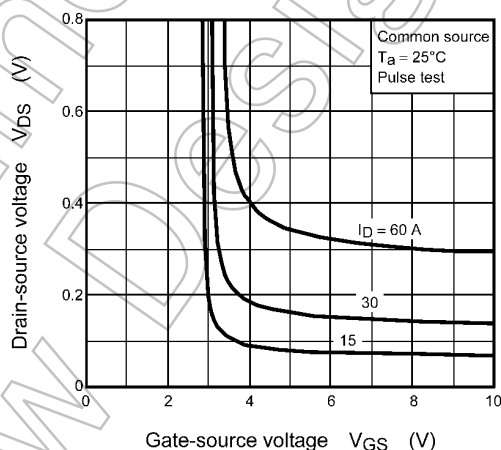
**Fig. 8.1  $I_D - V_{DS}$**



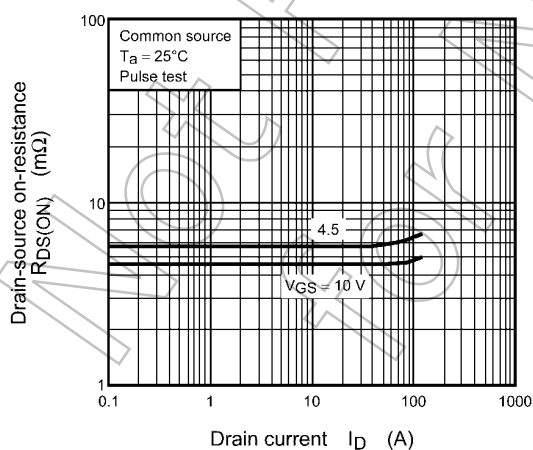
**Fig. 8.2  $I_D - V_{DS}$**



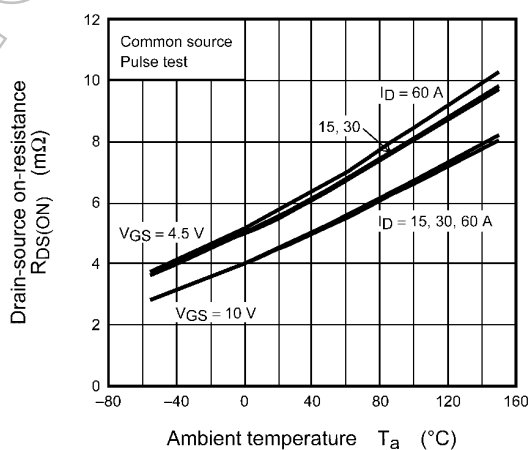
**Fig. 8.3  $I_D - V_{GS}$**



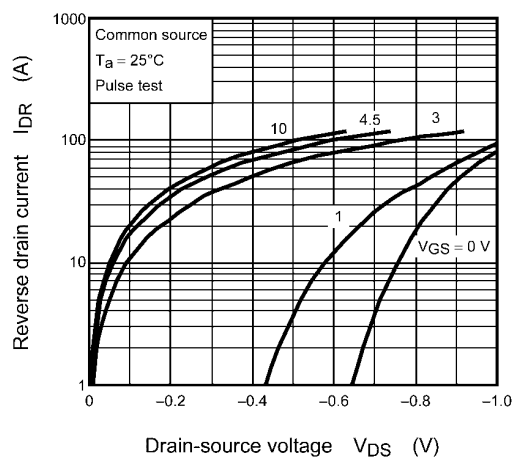
**Fig. 8.4  $V_{DS} - V_{GS}$**



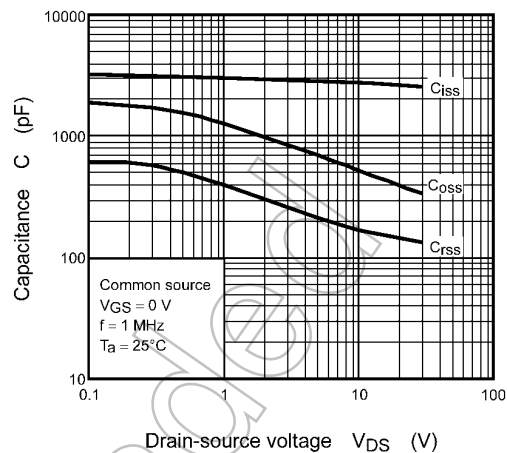
**Fig. 8.5  $R_{DS(ON)} - I_D$**



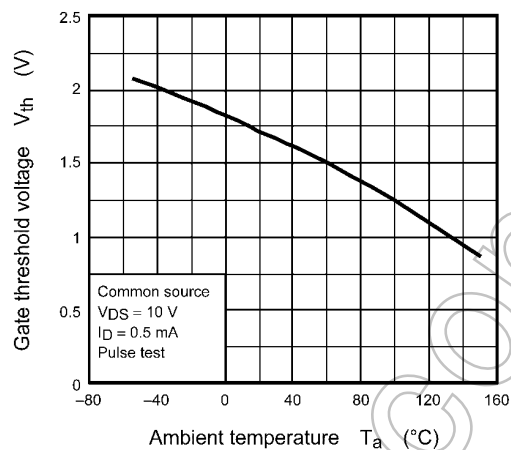
**Fig. 8.6  $R_{DS(ON)} - T_a$**



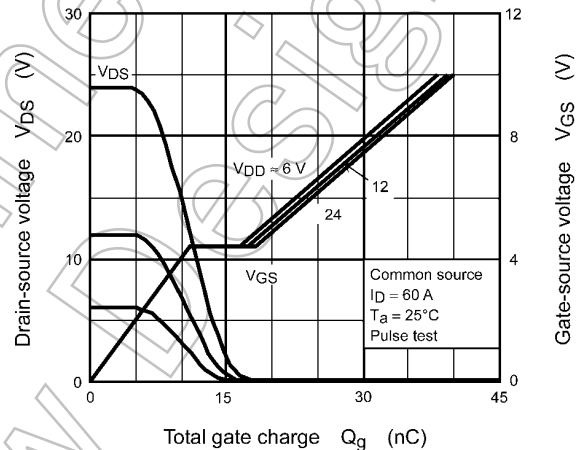
**Fig. 8.7  $I_{DR} - V_{DS}$**



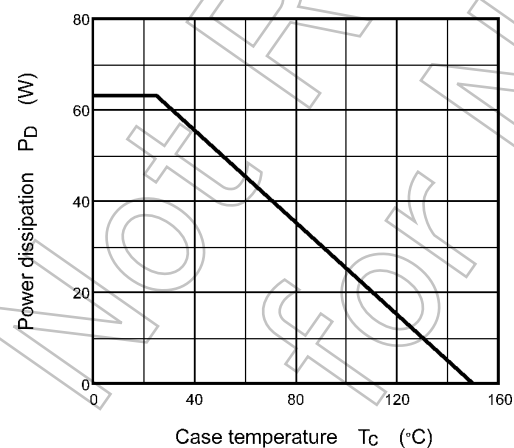
**Fig. 8.8 Capacitance -  $V_{DS}$**



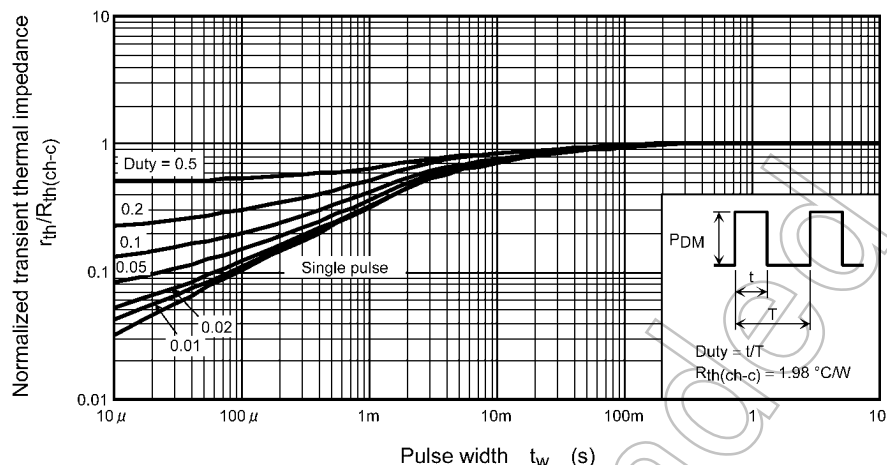
**Fig. 8.9  $V_{th} - T_a$**



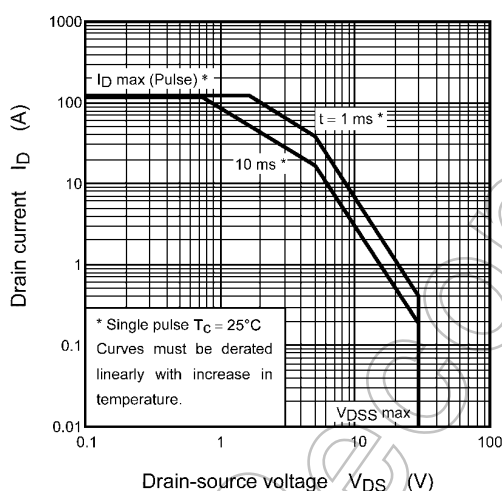
**Fig. 8.10 Dynamic Input/Output Characteristics**



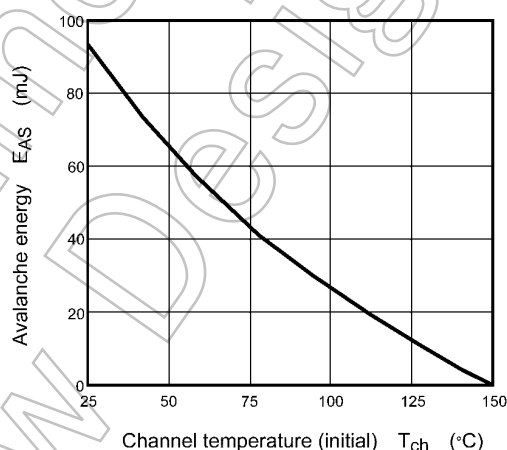
**Fig. 8.11  $P_D - T_c$   
 (Guaranteed Maximum)**



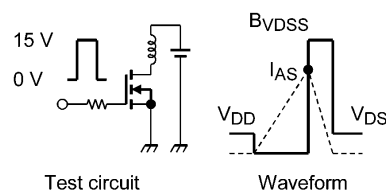
**Fig. 8.12  $r_{th}/R_{th(ch-c)} - t_w$**   
(Guaranteed Maximum)



**Fig. 8.13 Safe Operating Area**  
(Guaranteed Maximum)



**Fig. 8.14  $E_{AS} - T_{ch}$**   
(Guaranteed Maximum)



$$R_G = 1.2 \, \Omega$$

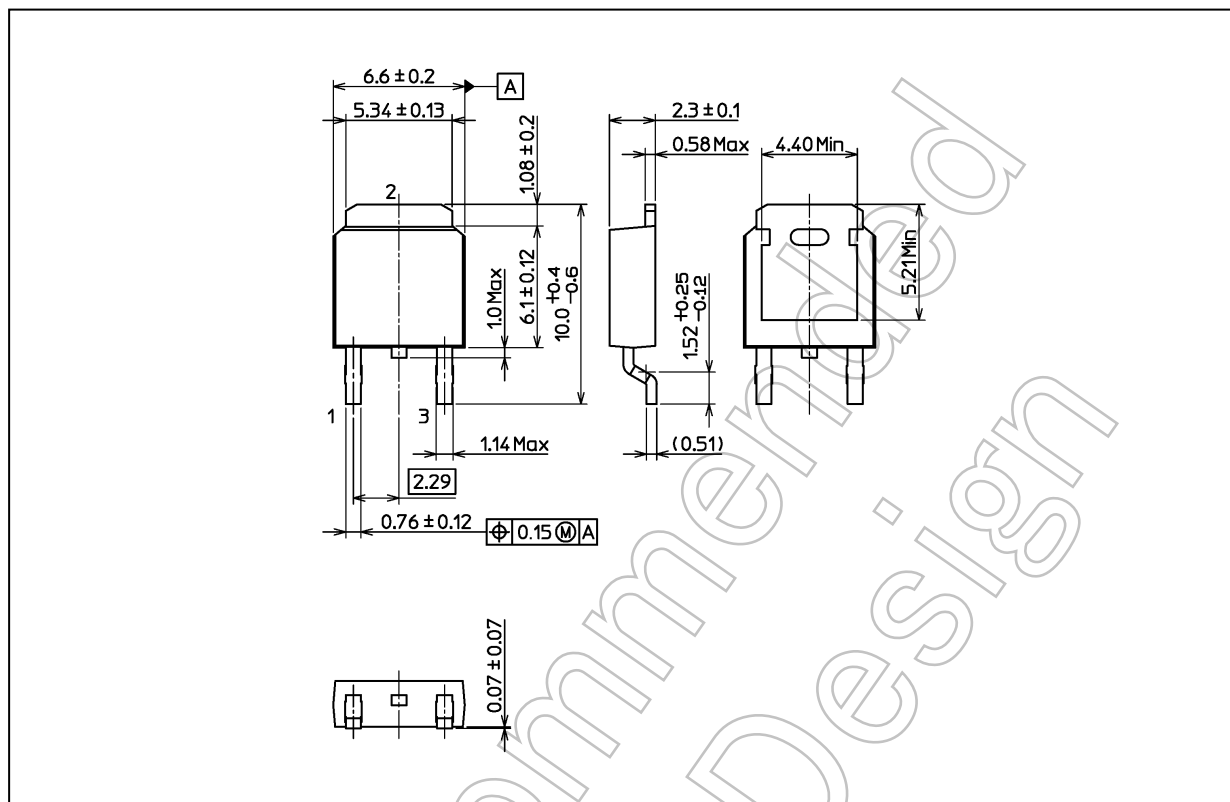
$$V_{DD} = 24 \, \text{V}, L = 0.02 \, \text{mH} \quad E_{AS} = \frac{1}{2} \cdot L \cdot I_{AS}^2 \cdot \left( \frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

**Fig. 8.15 Test Circuit/Waveform**

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

## Package Dimensions

Unit: mm



Weight: 0.36 g (typ.)

Package Name(s)
TOSHIBA: 2-7K1S
Nickname: DPAK



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